

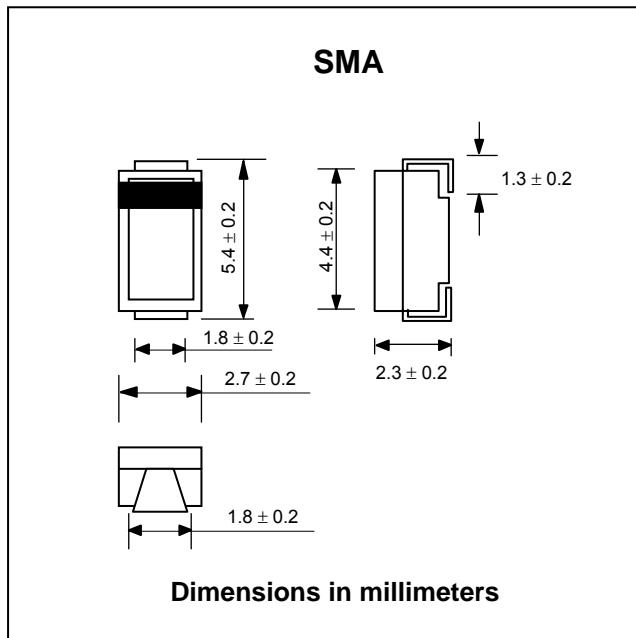
BZG03-C220 ~ BZG03-C270 VOLTAGE REGULATOR DIODES

FEATURES :

- * Complete Voltage Range 220 to 270 Volts
- * High maximum operating temperature
- * Excellent stability
- * Low leakage current
- * Pb / RoHS Free

MECHANICAL DATA :

- * Case : SMA Molded plastic
- * Epoxy : UL94V-O rate flame retardant
- * Polarity : Color band denotes cathode end
- * Mounting position : Any
- * Weight : 0.060 gram (Approximately)



MAXIMUM RATINGS

 (Rating at 25 °C ambient temperature unless otherwise specified)

Parameter	Symbol	Condition	Min.	Max.	Unit
Power dissipation	P _{tot}	T _{tp} = 100 °C, see Fig. 1	-	3	W
Power dissipation	P _{tot}	T _a = 50 °C, see Fig. 1; device mounted on an Al ₂ O ₃ PCB (Fig. 4)	-	1.25	W
Non-repetitive peak reverse	P _{ZSM}	t _p = 100 µs; square pulse; T _j = 25°C prior to surge; see Fig. 2	-	600	W
Forward voltage	V _F	I _F = 0.5 A; T _j = 25 °C; see Fig. 3	-	2.0	V
Junction Temperature Range	T _j		-65	+175	°C
Storage Temperature Range	T _{stg}		-65	+175	°C

THERMAL CHARACTERISTICS

Parameter	Symbol	Condition	Value	Unit
Thermal resistance from junction to tie-point	R _{th j-tp}		25	K/W
Thermal resistance from junction to ambient	R _{th j-a}	(Note 1)	100	K/W

Note

1. Device mounted on an Al₂O₃ printed-circuit board, 0.7 mm thick; thickness of Cu-layer ≥35 µm, see Fig.4.

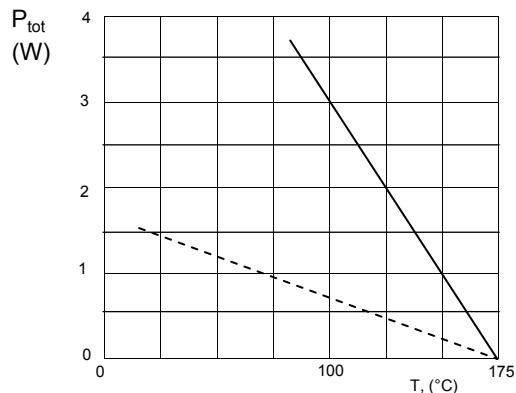
ELECTRICAL CHARACTERISTICS

 (Rating at T_j = 25 °C unless otherwise specified)

Type No.	Marking Code	Working Voltage			Differential Resistance		Temperature Coefficient		Test Current	Maximum Reverse Leakage Current	
		V _Z @ I _Z			r _{diff} (Ω) at I _Z		S _Z (%/K) at I _Z			I _R @ V _R	
		Min.	Nom.	Max.	Typ.	Max.	Min.	Max.	(mA)	(mA)	(V)
BZG03-C220	C220	208	220	233	350	750	0.09	0.13	2	1.0	160
BZG03-C240	C240	228	240	256	400	850	0.09	0.13	2	1.0	180
BZG03-C270	C270	251	270	289	450	1000	0.09	0.13	2	1.0	200

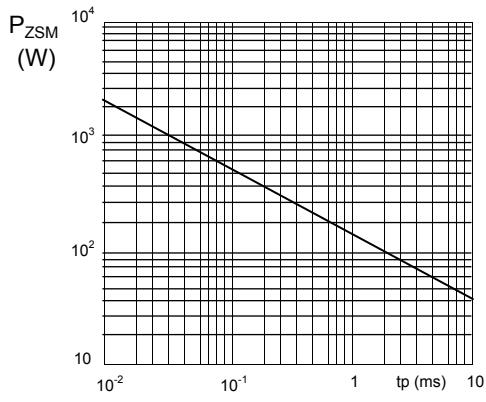
RATING AND CHARACTERISTIC CURVES (BZG03-C220 ~ BZG03-C270)

FIG.1 - Maximum total power dissipation as a function of temperature.



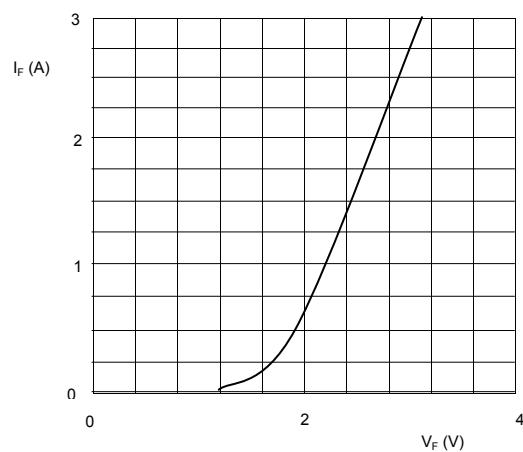
Solid line: tie-point temperature.
 Dotted line: ambient temperature; device mounted on an Al_2O_3 PCB as shown in Fig.5.

FIG.2 - Maximum non-repetitive peak reverse power dissipation as a function of pulse duration (square pulse).



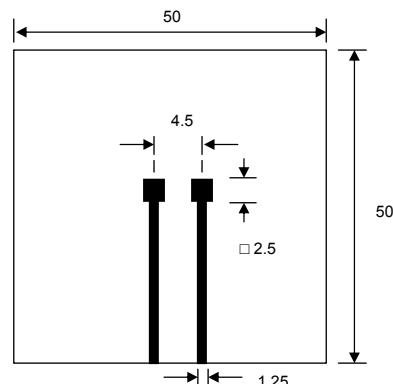
T_j = 25 °C prior to surge.

FIG. 3 - Forward current as a function of forward voltage; typical values.



T_j = 25 °C.

FIG.4 - Printed-circuit board for surface mounting.



Dimensions in mm.